

## Electronic Acknowledgement Receipt

<b>EFS ID:</b>	4859721
<b>Application Number:</b>	10756122
<b>International Application Number:</b>	
<b>Confirmation Number:</b>	4554
<b>Title of Invention:</b>	Low dielectric constant film produced from silicon compounds comprising silicon-carbon bond
<b>First Named Inventor/Applicant Name:</b>	Wai-Fan Yau
<b>Customer Number:</b>	44257
<b>Filer:</b>	Keith M. Tackett/Nyweli Houston
<b>Filer Authorized By:</b>	Keith M. Tackett
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<b>Receipt Date:</b>	25-FEB-2009
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<b>Time Stamp:</b>	18:52:59
<b>Application Type:</b>	Utility under 35 USC 111(a)

### Payment information:

Submitted with Payment	no
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### File Listing:

Document Number	Document Description	File Name	File Size(Bytes)/ Message Digest	Multi Part /.zip	Pages (if appl.)
1		002592C7_SIDS_EF.pdf	142417 7f30926b143fb7e47897168b2ed90617a3cfb098	yes	4

	Multipart Description/PDF files in .zip description				
	Document Description		Start	End	
	Information Disclosure Statement Letter		1	2	
	Information Disclosure Statement (IDS) Filed (SB/08)		3	4	
Warnings:					
Information:					
2	Foreign Reference	JP06168930_EF.pdf	4559580	no	83
			7548acc1089ed0ad330140023e35937d1f27f6b7		
Warnings:					
Information:					
3	Foreign Reference	JP07029897_EF.pdf	1350293	no	30
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Warnings:					
Information:					
4	Foreign Reference	JP10313003_EF.pdf	1720371	no	31
			f1cbd636e973bd55287bc1783da804e46a888f95		
Warnings:					
Information:					
5	NPL Documents	002592JP_OfficeAcion20081125_EF.pdf	144437	no	4
			3e0b0aa2047557fd7cc9fdadd1df8bec879a87f		
Warnings:					
Information:					
Total Files Size (in bytes):			7917098		

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**New Applications Under 35 U.S.C. 111**

**If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.**

**National Stage of an International Application under 35 U.S.C. 371**

**If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.**

**New International Application Filed with the USPTO as a Receiving Office**

**If a new international application is being filed and the international application includes the necessary components for an international filing date (see PCT Article 11 and MPEP 1810), a Notification of the International Application Number and of the International Filing Date (Form PCT/RO/105) will be issued in due course, subject to prescriptions concerning national security, and the date shown on this Acknowledgement Receipt will establish the international filing date of the application.**